

1A, 200V - 1000V Surface Mount Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication

MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Mattle tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.027 g (approximately)

| KEY PARAMETERS | | | | | | |
|--------------------|------------|------|--|--|--|--|
| PARAMETER | VALUE | UNIT | | | | |
| I _{F(AV)} | 1 | Α | | | | |
| V_{RRM} | 200 - 1000 | V | | | | |
| I _{FSM} | 30 | Α | | | | |
| T_{JMAX} | 150 | °C | | | | |
| Package | SOD-128 | | | | | |
| Configuration | Single die | | | | | |

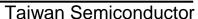




SOD-128

| PARAMETER | SYMBOL | S1DFS | S1GFS | S1JFS | S1KFS | S1MFS | UNIT |
|---|---------------------|-------------------------------|-------|-------|-------|-------|------|
| Marking code on the device | | S1DFS | S1GFS | S1JFS | S1KFS | S1MFS | |
| Repetitive peak reverse voltage | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms value | V _{R(RMS)} | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | I _{F(AV)} | | | 1 | | | Α |
| Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode | I _{FSM} | | | 30 | | | А |
| Junction temperature | TJ | - 55 to +150 | | °C | | | |
| Storage temperature | T _{STG} | T _{STG} - 55 to +150 | | | °C | | |

1





| THERMAL PERFORMANCE | | | | | | |
|--|------------------|-------|------|--|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | |
| Junction-to-lead thermal resistance per diode | $R_{\Theta JL}$ | 29 | °C/W | | | |
| Junction-to-ambient thermal resistance per diode | R _{OJA} | 82 | °C/W | | | |
| Junction-to-case thermal resistance per diode | R _{eJC} | 30 | °C/W | | | |

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | | |
|--|---|----------------|------|------|------|--|
| PARAMETER | CONDITIONS | SYMBOL | TYP | MAX | UNIT | |
| Forward voltage per diode (1) | $I_F = 0.5A, T_J = 25^{\circ}C$ | V _F | 0.91 | 1.0 | V | |
| | $I_F = 1.0A, T_J = 25^{\circ}C$ | | 0.99 | 1.1 | V | |
| | I _F = 0.5A, T _J = 125°C | | 0.78 | 0.87 | V | |
| | I _F = 1.0A, T _J = 125°C | | 0.85 | 0.95 | V | |
| Deverse surrent @ reted // per diede (2) | T _J = 25°C | | - | 1 | μA | |
| Reverse current @ rated V _R per diode ⁽²⁾ | T _J = 125°C | I _R | - | 50 | μA | |
| Junction capacitance | 1 MHz, V _R =4.0V | CJ | 9 | - | pF | |

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

| ORDERING INFORMATION | | | | | | |
|----------------------|-----------------------|-----------------|------------------------|---------|---------------------------|--|
| PART NO. | PART NO. SUFFIX(*) | PACKING CODE | PACKING CODE SUFFIX | PACKAGE | PACKING | |
| S1xFS | н | MW | G | SOD-128 | 3,500 / 7" Plastic reel | |
| (Note 1, 2) | П | MX | | SOD-128 | 14,000 / 13" Plastic reel | |

Notes:

- 1. "xx" defines voltage from 200V (S1DFS) to 1000V (S1MFS)
- 2. Whole series with green compound (halogen-free)
- *: Optional available

| EXAMPLE P/N | | | | | | |
|-------------|----------|--------------------|-----------------|------------------------|--------------------------------------|--|
| EXAMPLE P/N | PART NO. | PART NO. SUFFIX | PACKING CODE | PACKING CODE SUFFIX | DESCRIPTION | |
| S1DFSHMWG | S1DFS | Н | MW | G | AEC-Q101 qualified Green compound | |



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

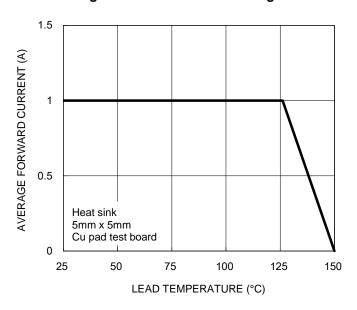


Fig.2 Typical Junction Capacitance

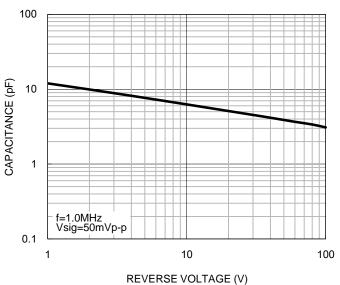


Fig.3 Typical Reverse Characteristics

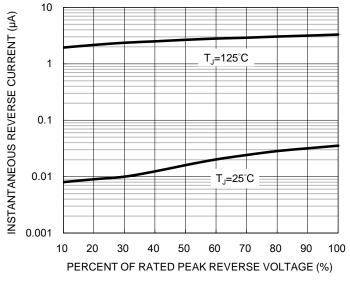
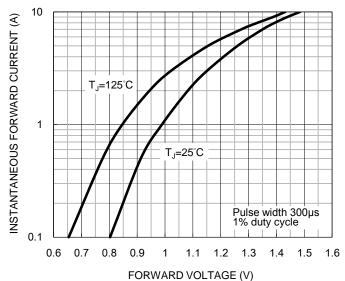


Fig.4 Typical Forward Characteristics

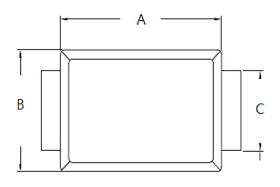


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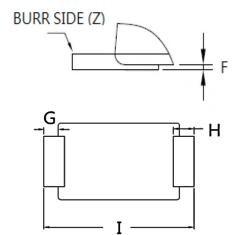


PACKAGE OUTLINE DIMENSIONS

SOD-128

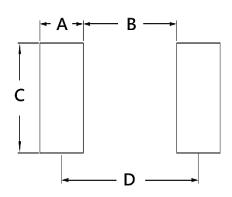






| DIM | Unit | (mm) | Unit (inch) | | |
|-------|------|------|-------------|-------|--|
| DIIVI | Min | Max | Min | Max | |
| Α | 3.60 | 4.00 | 0.142 | 0.157 | |
| В | 2.30 | 2.70 | 0.091 | 0.106 | |
| С | 1.60 | 1.90 | 0.063 | 0.075 | |
| D | 0.90 | 1.10 | 0.035 | 0.043 | |
| E | 0.10 | 0.22 | 0.004 | 0.009 | |
| F | 0.00 | 0.10 | 0.000 | 0.004 | |
| G | 0.30 | 0.60 | 0.012 | 0.024 | |
| Н | 0.40 | 0.80 | 0.016 | 0.031 | |
| I | 4.40 | 5.00 | 0.173 | 0.197 | |

SUGGESTED PAD LAYOUT



| DIM | Unit (mm) | Unit (inch) |
|-----|-----------|-------------|
| Α | 1.40 | 0.055 |
| В | 3.00 | 0.118 |
| С | 2.10 | 0.082 |
| D | 4.40 | 0.173 |

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code F = Factory Code



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